



## THE TECHNICAL UNIVERSITY OF KENYA

### 5<sup>TH</sup> INTERNATIONAL CONFERENCE

November 16-20, 2026 | 📍 The Technical University of Kenya

## CONFERENCE ANNOUNCEMENT AND CALL FOR PAPERS

### About the Conference

The Technical University of Kenya (TU-K) will host the TUK Research Week 2026, culminating in the 5th International Conference, from November 16th to 20th, 2026, in Nairobi, Kenya. Driven by the theme "Building Integrated Innovation Ecosystems Beyond 2030: The Role of Technology, Training and Governance," the event aligns with the long-term development aspirations of Kenya Vision 2030, the African Union Agenda 2063, and the Sustainable Development Goals. It aims to foster a multidisciplinary environment where researchers, industry leaders, policymakers, practitioners, and students can showcase cutting-edge research, promote interdisciplinary partnerships, and enhance the commercialization of knowledge to address emerging societal and industrial challenges.

The five-day program is structured to include test runs, research and innovation exhibitions, faculty-led workshops, and parallel scientific sessions across various academic disciplines, including applied sciences, engineering, and social sciences. Key milestones leading up to the conference include a call for abstracts and papers launching in July 2026, followed by paper submissions and registrations through October 2026. Ultimately, the event expects to attract a global cohort of participants and sponsors from academia, government agencies, and private sectors, resulting in strengthened institutional partnerships, published conference proceedings, and actionable policy recommendations for inclusive innovation ecosystems.

## THEME:

***“Building Intergrated Ecosystems Beyond 2030: The Role of Technology, Training and Governance”***

**Sub-Themes:** The Sub-Themes include but not restricted, to:

1. Bio innovation, Biotechnology and the Future Bioeconomy
2. Mathematical Modelling, Data Science and AI in Sciences
3. Nanotechnology and Advanced Materials for Sustainable Development
4. Innovating Safety and Security; from Laboratory Best Practices to Cross-border Threat Reduction
5. Digital Agriculture and Sustainable Biotechnology
6. Towards Multi-Disciplinary Earth Solutions: The Role of Physics, Earth and Environmental Sciences in Shaping Sustainable Futures Smart Infrastructure, Sustainable Cities, and the Built Environment
7. Advanced Manufacturing, Industrial Automation and Industry 4.0 Technologies.
8. Green Engineering, Renewable Energy Systems and Climate Resilience
9. Artificial Intelligence, Robotics and Emerging Engineering Innovations
10. Open Knowledge, Inclusion, and Cultural Heritage Preservation
11. The future of Diplomacy, Cybersecurity, and Social Stability in a Networked World
12. Digital Rights in Digital Societies
13. Capacity Building for the New Workplace
14. Commercialization of Innovations
15. Digital Communication, Media and Behavioral Change in the New Social Order

### Abstract and Poster Submission Guidelines

#### ABSTRACTS

Title of the Abstract  
Complete names of author(s)  
Institution affiliation (+ city and country)  
Email address and cell phone number  
All submissions must be in English.  
Submissions must be in PDF format.

#### POSTER

As per the published guidelines in the conference website.

### Important Dates:

- Abstract: Maximum 300 words and a short author bibliography of 100 words. Submission Deadline: **15<sup>th</sup> September, 2026**
- Notification of Abstract Acceptance: **30<sup>th</sup> September, 2026**
- Full Paper: Maximum 6,000 words (including references, tables, and figures). Submission Deadline: **30<sup>th</sup> October, 2026**
- Conference Dates: **November 16-20, 2026**

#### Citation Style:

- APA (American Psychological Association) style is preferred for citations and references. IEEE Referencing is accepted for Engineering and Technology Papers.
- Use in-text citations and provide a list of references at the end of the paper.

### Sponsorship Opportunities:

#### Conference Sponsorship Packages

| Level                                               | Amount (KSH) | Benefits                                                                                                                            |
|-----------------------------------------------------|--------------|-------------------------------------------------------------------------------------------------------------------------------------|
| <b>Strategic Partner</b>                            | 2,000,000    | High-Level B2B Networking and Policy Influence. Direct Access to a Premium Tech & Engineering Talent Pipeline. Entry for 20 guests. |
| <b>Platinum</b>                                     | 1,500,000    | Exclusive branding, Speaking slot, Prime Exhibition Space, VIP access, Media coverage. Entry for 10 guests.                         |
| <b>Gold</b>                                         | 1,000,000    | Prominent branding, presentation opportunity, Enhanced exhibition space, VIP access. Entry for 5 guests.                            |
| <b>Silver</b>                                       | 500,000      | Branding on event materials, Standard exhibition space, Networking opportunities. Entry for 3 guests.                               |
| <b>Bronze</b>                                       | 100,000      | Logo placement, participation in event activities. Entry for 2 guests.                                                              |
| <b>ANY OTHER IN-KIND DONATIONS ARE MOST WELCOME</b> |              |                                                                                                                                     |

### Conference Format and Venue

The Conference will be held at the Technical University of Kenya Grounds, and will adopt a hybrid model including a virtual component to enable broader participation, with flexibility to allow a much wider participation from around the globe.

Once you prepare your abstract according to the above guidelines, use the subject line **“5<sup>th</sup> Technical University of Kenya International Conference 2026**” and email your submission to: [tukconference2026@tukenya.ac.ke](mailto:tukconference2026@tukenya.ac.ke)

### Conference Registration and Poster Presentation Fees

Payments to be made to the KCB Account 1101631953, Moi Avenue, Swift Code KCBLENX as follows (Attach payment evidence to the email above):

| Participants                              | KES     | USD | Benefits                                                       |
|-------------------------------------------|---------|-----|----------------------------------------------------------------|
| Undergraduate Students' Abstracts/Posters | 500     | 4   | Conference Tags, Access to all conference facilities and meals |
| Kenyan Masters Students' Abstracts        | 7,500   | 60  |                                                                |
| Kenyan PhD Students' Abstracts            | 10,500  | 80  |                                                                |
| East African Participants/Delegates       | 5,000   | 40  |                                                                |
| International Participants/Delegates      |         | 200 |                                                                |
| Poster Presentation                       | 3,500   | 27  |                                                                |
| Excursion Booths                          | 100,000 | 773 |                                                                |

### Contact Information:

For any inquiries or assistance regarding paper submission, please email [tukconference2026@tukenya.ac.ke](mailto:tukconference2026@tukenya.ac.ke) or [research@tukenya.ac.ke](mailto:research@tukenya.ac.ke) or visit <https://tukenya.ac.ke/5th-conference/#home>

Please share this call for abstracts/papers within your networks.